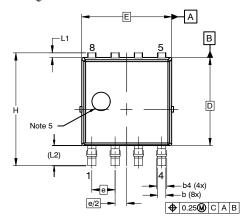
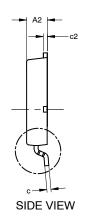




DATE 22 APR 2024





NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.150mm PER SIDE.
- DIMENSIONS DAND EARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.

DIM

Α Α1

A2

АЗ

b

b4

С

c2

D

D1

D2

D3

D4

Ε

E1

E2

е

e/2

Н

L

L1

θ

MILLIMETERS

1.20

0.08

1.15

0.25 BSC

0.55

0.22

0.22

4.80

4.00

3.08

0.40

0.65

4.90

5.15

3.96

1.27 BSC

0.635 BSC

0.25

1.10 REF

4°

6.15 6.30

0.70 0.90

0.45

NOM MAX

1.30

0.15

1.20

0.50

0.65

0.25

0.25

4.90

4.20

3.18

0.50

0.75

5.00

5.25

4.01

0.35

8°

MIN

1.10

0.00

1.10

0.40

0.45

0.19

0.19

4.70

3.80

2.98

0.30

0.55

4.80

5.05

3.91

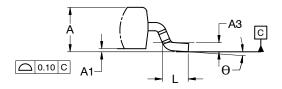
0.50

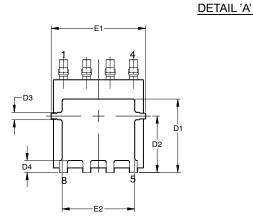
0.15

0°

OPTIONAL MOLD FEATURE.

TOP VIEW





BOTTOM VIEW

4 51 0.70 0.60 2.05 6.42 0.60 0.70 1.06 1.15 0.70 (8X)

RECOMMENDED LAND PAD

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXXXXX = Specific Device Code

= Assembly Location Α WL = Wafer Lot = Year ٧

*This information is generic. Please refer to device data sheet for actual part marking. Some products may not follow the Generic Marking.

98AON82475G

= Work Week

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DESCRIPTION:

W

LFPAK8 4.90x4.80x1.12MM, 1.27P

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